VS-HFA210NJ60CPbF

Vishay Semiconductors

HEXFRED[®] Ultrafast Soft Recovery Diode, 210 A



210 A

600 V

120 A at 100 °C

TO-244 (TO-244AB)

Two diodes common cathode

PRODUCT SUMMARY

I_{F(AV)}

 V_{R}

I_{F(DC)} at T_C

Package

Circuit

www.vishay.com

FEATURES

- Very low Q_{rr} and t_{rr}
- UL approved file E222165
- · Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

BENEFITS

- · Reduced RFI and EMI
- Reduced snubbing

DESCRIPTION

HEXFRED® diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. An extensive characterization of the recovery behavior for different values of current, temperature and dl_F/dt simplifies the calculations of losses in the operating conditions. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for power converters, motors drives and other applications where switching losses are significant portion of the total losses.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Cathode to anode voltage	V _R		600	V	
Continuous forward current		T _C = 25 °C	235		
	IF	T _C = 100 °C	120	А	
Single pulse forward current	I _{FSM}	Limited by junction temperature	600		
Non-repetitive avalanche energy	E _{AS}	L = 100 $\mu H,$ duty cycle limited by maximum $T_{\rm J}$	2.2	mJ	
Maximum power dissipation	D	T _C = 25 °C	463		
	P _D	T _C = 100 °C	185	W	
Operating junction and storage temperature range	T _J , T _{Stg}		-55 to +150	°C	

ELECTRICAL SPECIFICATIONS PER LEG ($T_J = 25 \text{ °C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V _{BR}	I _R = 100 μA		600	-	-	
Maximum forward voltage		I _F = 105 A		-	1.38	1.9	v
	V _{FM}	I _F = 210 A	See fig. 1	-	1.6	2.25	
		I _F = 105 A, T _J = 125 °C		-	1.3	1.56	
Maximum reverse leakage current	I _{RM}	$T_{J} = 125 \ ^{\circ}C, \ V_{R} = 480 \ V$	See fig. 2	-	1.8	6.0	mA
Junction capacitance	CT	V _R = 200 V	See fig. 3	-	200	300	pF
Series inductance	Ls	From top of terminal hole to mounting plane		-	6.0	-	nH

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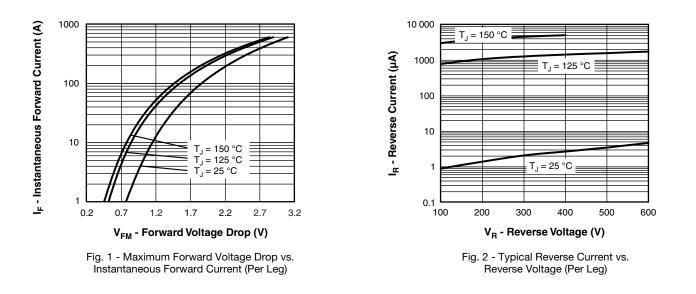
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DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS	
Reverse recovery time (fig. 5)	t _{rr}	$I_F = 1.0 \text{ A}, dI_F/dt = 200 \text{ A}/\mu \text{s}, V_R = 30 \text{ V}$		-	35	-		
		T _J = 25 °C		-	90	140	ns	
		T _J = 125 °C		-	160	240		
Peak recovery current (fig. 6)		T _J = 25 °C		-	10	18	٨	
	IRRM	T _J = 125 °C	$I_{\rm F} = 105 {\rm A}$	-	15	30	A	
Reverse recovery charge (fig. 7)	0	T _J = 25 °C	dI _F /dt = 200 A/µs V _R = 200 V	-	450	1300	nC	
	Q _{rr}	T _J = 125 °C		-	1200	3600		
Peak rate of recovery current (fig. 8)	مال (ماله	al (at	T _J = 25 °C		-	310	-	A/uo
	dl _{(rec)M} /dt	T _J = 125 °C		-	240	-	A/µs	

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS		
Maximum junction and storage temperature range	T _J , T _{Stg}	-55	-	150	°C		
Thermal resistance, junction to case per leg	R _{thJC}	-	-	0.27	°C/W K/W		
per module		-	-	0.135			
Typical thermal resistance, case to heatsink	R _{thCS}	-	0.10	-			
Weight		-	68	-	g		
Weight		-	2.4	-	oz.		
Mounting torque ⁽¹⁾		30 (3.4)	-	40 (4.6)			
Mounting torque center hole		12 (1.4)	-	18 (2.1)	lbf · in (N · m)		
Terminal torque		30 (3.4)	-	40 (4.6)	· · ·		
Vertical pull		-	-	80	lbf ⋅ in		
2" lever pull		-	-	35			

Note

(1) Mounting surface must be smooth, flat, free of burrs or other protrusions. Apply a thin even film or thermal grease to mounting surface. Gradually tighten each mounting bolt in 5 to 10 lbf · in steps until desired or maximum torque limits are reached



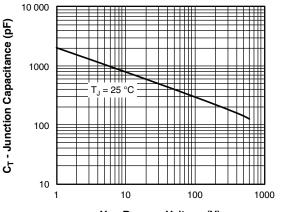
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V_R - Reverse Voltage (V)

Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

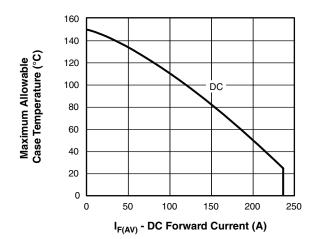


Fig. 4 - Maximum Allowable Case Temperature vs. DC Forward Current (Per Leg)

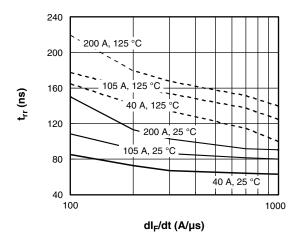


Fig. 5 - Typical Reverse Recovery Time vs. dl_F/dt (Per Leg)

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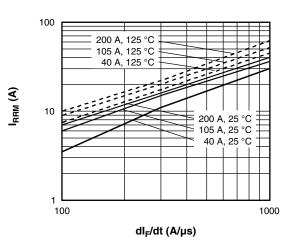
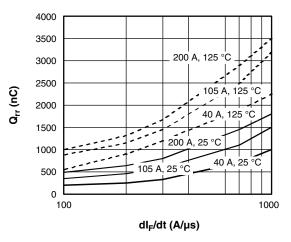


Fig. 6 - - Typical Recovery Current vs. dl_F/dt (Per Leg)





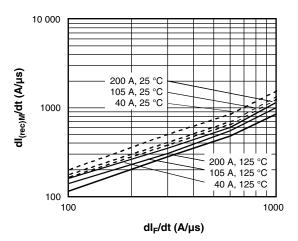


Fig. 8 - - Typical dI_{(rec)M}/dt vs. dI_F/dt (Per Leg)

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t₁ - Rectangular Pulse Duration (s)

Fig. 9 - - Maximum Thermal Impedance ZthJC Characteristics (Per Leg)

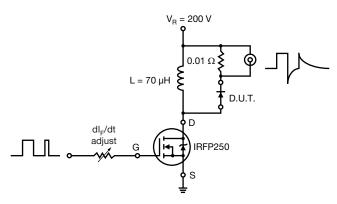
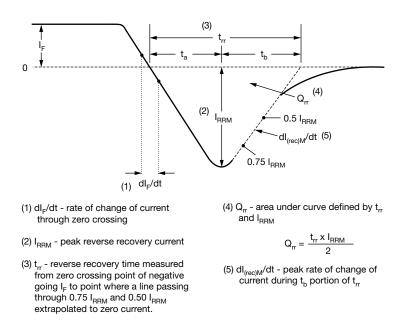
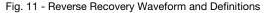


Fig. 10 - - Reverse Recovery Parameter Test Circuit





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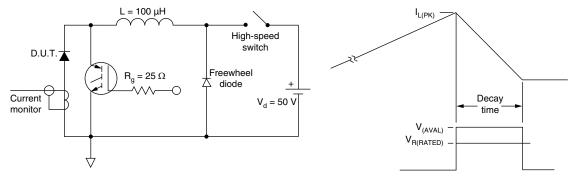
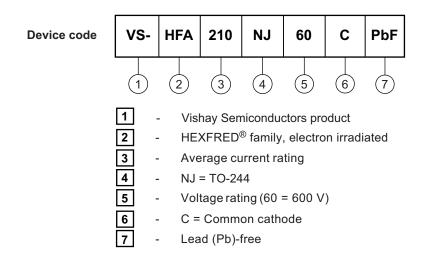


Fig. 12 - Avalanche Test Circuit and Waveforms

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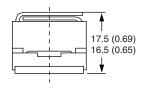


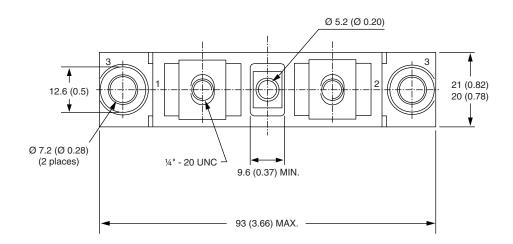
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TO-244

DIMENSIONS in millimeters (inches)









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